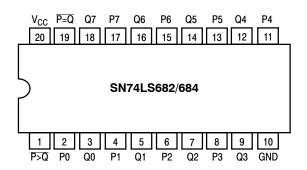
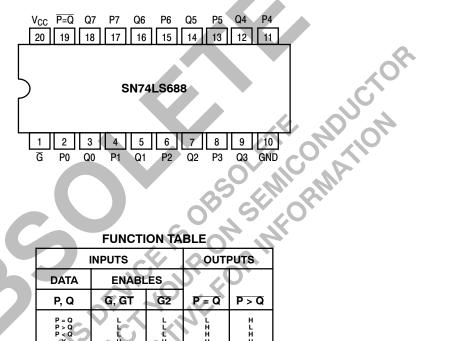
CONNECTION DIAGRAMS (TOP VIEW)





	NPUTS	OUTPUTS		
DATA	ENABL	ES.		5
P, Q	G, GT	G2	P = Q	P > Q
P = Q P > Q P < Q X	-3-2	JJUE	JEEE	111

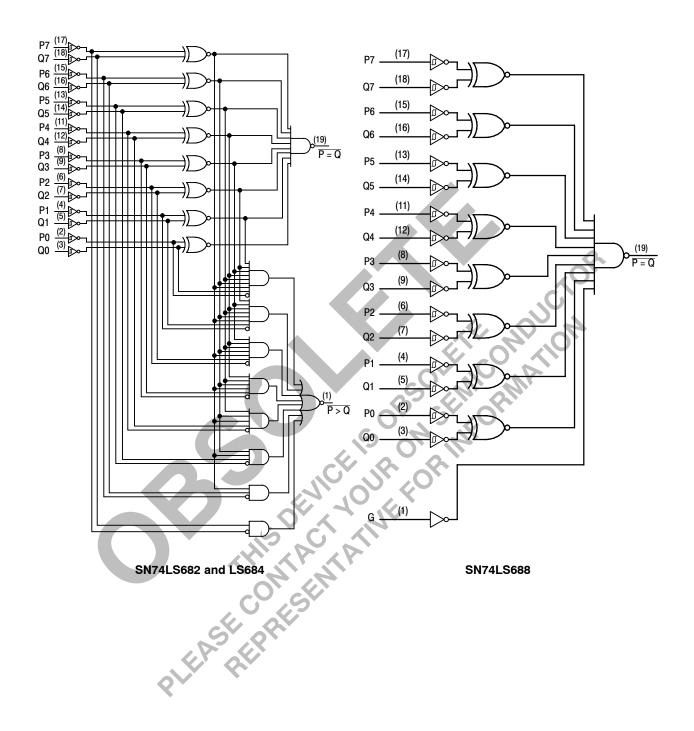
= HIGH Level, L = LOW Level, X = Irrelevant

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

Symbol				Limits				
	Parame	eter	Min	Тур	Max	Unit	Test	Conditions
V _{IH}	Input HIGH Voltage		2.0			V	Guaranteed Inpu All Inputs	t HIGH Voltage for
V _{IL}	Input LOW Voltage				0.8	٧	Guaranteed Inpu All Inputs	t LOW Voltage for
V _{IK}	Input Clamp Diode Vo	oltage		-0.65	-1.5	V	V _{CC} = MIN, I _{IN} =	–18 mA
V _{OH}	Output HIGH Voltage		2.7	3.5		V	V _{CC} = MIN, I _{OH} = or V _{IL} per Truth T	
				0.25	0.4	V	I _{OL} = 12 mA	V _{CC} = V _{CC} MIN,
V _{OL}	Output LOW Voltage			0.35	0.5	V	I _{OL} = 24 mA	V _{IN} = V _{IL} or V _{IH} per Truth Table
					20	μА	V _{CC} = MAX, V _{IN}	·
I _{IH}	Input HIGH Current	LS682-Q Inputs			0.1	mA	$V_{CC} = MAX, V_{IN}$	
		Others			0.1	mA	$V_{CC} = MAX, V_{IN}$	
		LS682-Q Inputs			-0.4	mA		<u> </u>
I _{IL}	Input LOW Current	Others			-0.2	mA	$V_{CC} = MAX, V_{IN}$	= 0.4 V
I _{OS}	Short Circuit Current	(Note 1)	-30		-130	mA	V _{CC} = MAX	4
	Power Supply	LS682			70	mA	1, 4,	<i>(</i> 0 <i>)</i>
I _{CC}		LS684			65	mA	V _{CC} = MAX	
	Julient	LS688			65	mA	112 21/1	
	Short Circuit Current Power Supply Current e than one output should		OEVI	40)	JA C	OR	AFO.	

^{1.} Not more than one output should be shorted at a time, nor for more than 1 second.

LOGIC DIAGRAMS



AC CHARACTERISTICS $(T_A = 25^{\circ}C)$

SN74LS682

			Limits			
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
t _{PLH} t _{PHL}	Propagation Delay, P to $\overline{P} = \overline{Q}$		13 15	25 25	ns	
t _{PLH} t _{PHL}	Propagation Delay, Q to $\overline{P} = \overline{Q}$		14 15	25 25	ns	V _{CC} = 5.0 V C _L = 45 pF
t _{PLH} t _{PHL}	Propagation Delay, P to $\overline{P} > \overline{Q}$		20 15	30 30	ns	$R_L = 667 \Omega$
t _{PLH} t _{PHL}	Propagation Delay, Q to $\overline{P > Q}$		21 19	30 30	ns	

SN74LS684

			Limits			
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
t _{PLH} t _{PHL}	Propagation Delay, P to $\overline{P} = \overline{Q}$		15 17	25 25	ns	×0/
t _{PLH} t _{PHL}	Propagation Delay, Q to $\overline{P} = \overline{Q}$		16 15	25 25	ns	V_{CC} = 5.0 V C_L = 45 pF
t _{PLH} t _{PHL}	Propagation Delay, P to $\overline{P} > \overline{Q}$		22 17	30 30	ns	C _L = 45 pr R _L = 667 Ω
t _{PLH} t _{PHL}	Propagation Delay, Q to P > Q		24 20	30 30	ns	MICHA

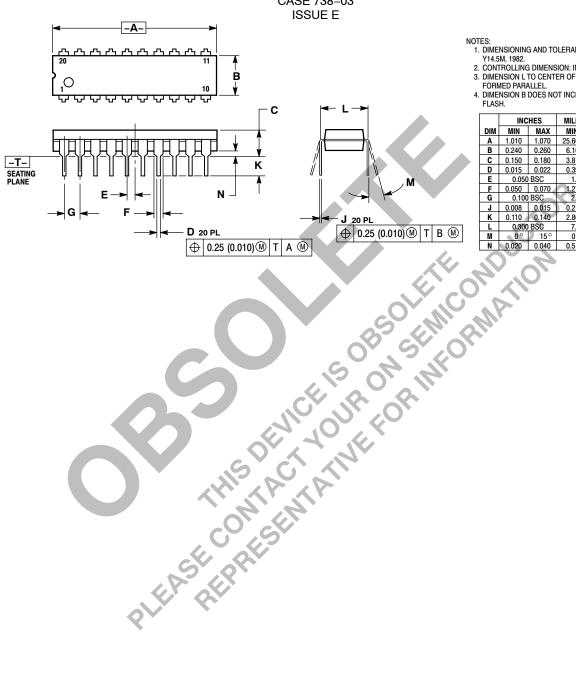
SN74LS688

			Limits	2	19	71,
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
t _{PLH} t _{PHL}	Propagation Delay, P to $\overline{P} = \overline{Q}$		12 17	18 23	ns	
t _{PLH} t _{PHL}	Propagation Delay, Q to $\overline{P} = \overline{Q}$	000	12 17	18 23	ns	V_{CC} = 5.0 V C_L = 45 pF R_L = 667 Ω
t _{PLH} t _{PHL}	Propagation Delay, \overline{G} , $\overline{G1}$ to $\overline{P} = \overline{Q}$		12 13	18 20	ns	_
	PLEASERPR	KSE.				

PACKAGE DIMENSIONS

N SUFFIX

PLASTIC PACKAGE CASE 738-03



NOTES:

- OTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: INCH.

 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL

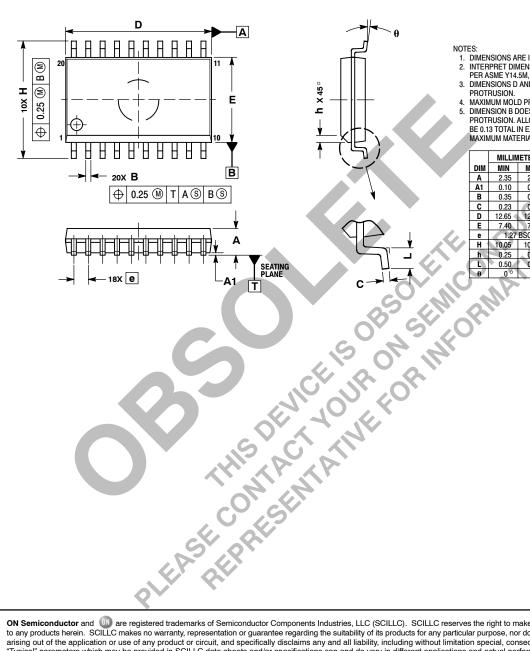
- 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	1.010	1.070	25.66	27.17	
В	0.240	0.260	6.10	6.60	
С	0.150	0.180	3.81	4.57	
D	0.015	0.015 0.022		0.55	
Е	0.050	BSC	1.27 BSC		
F	0.050	0.070	1.27	1.77	
G	0.100	BSC	2.54 BSC		
J	0.008	0.015	0.21	0.38	
K	0.110	0.140	2.80	3.55	
L	0.300	BSC	7.62	BSC	
M	0°	15°	0°	15°	
N	0.020	0.040	0.51	1.01	

PACKAGE DIMENSIONS

DW SUFFIX

PLASTIC SOIC PACKAGE CASE 751D-05 ISSUE F



- DIMENSIONS ARE IN MILLIMETERS.
- INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
 - MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
 DIMENSION B DOES NOT INCLUDE DAMBAR
- PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION

	MILLIMETERS			
DIM	MIN	MAX		
Α	2.35	2.65		
A1	0.10	0.25		
В	0.35	0.49		
С	0.23	0.32		
D	12.65	12.95		
Е	7.40	7.60		
е	1.27 BSC			
H 4	10.05	10.55		
h	0.25	0.75		
L	0.50	0.90		
θ	0 °	7 °		

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